High-Voltage, Linear High-Brightness LED Driver IC CN5501

General Description:

The CN5501 current regulator operates from a 4V to 32V input voltage range and delivers up to a total of 1A to one or more strings of high-brightness LEDs. The output current of the CN5501 is adjusted by using an external current-sense resistor in series with the LEDs. An enable input allows wide-range "pulsed" dimming. The CN5501 is well suited for applications requiring high-voltage input and is able to withstand automotive load-dump events up to 32V. An on-chip power MOSFET minimizes external components while providing ±5% output current accuracy.

Also an EQ pin is adopted for equalizing LED current among multiple CN5501 used in parallel. Additional features include a 5V regulated output and thermal regulation, etc.

The CN5501 is available in a thermally enhanced 8-pin SOP package and 8-pin DFN package.

Applications:

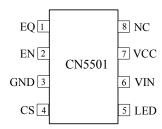
- Lighting Systems
- Automotive Interior and Exterior
- Navigation indicators
- Instrumentation illumination
- Signage and Beacons

Features:

- 4V to 32V Operating Voltage
- Adjustable LED Current up to 1A
- Integrated 32V, 1A MOSFET with 1.5A Current Limit(Typical)
- Low Current-Sense Voltage Reduces Power Loss
- Typical 5% LED Current Accuracy
- High-Voltage Chip Enable Input for Dimming Interface
- Current Equalizing Among Multiple CN5501 Used in Parallel
- Thermal Regulation
- Operating Temperature Range:

- Available in Thermally-enhanced 8 pin SOP or 8-pin DFN package.
- Pb-free, Rohs Compliant and Halogen Free

Pin Assignment



Typical Application Circuit

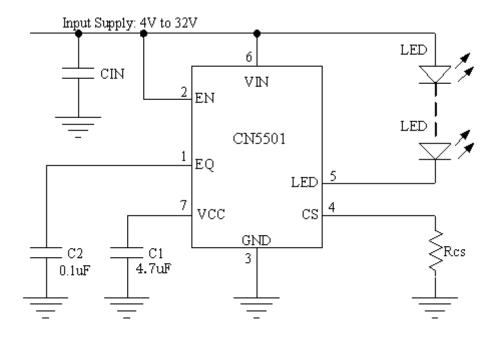


Figure 1 Typical Application Circuit

Ordering Information

Part Number	Package	Shipping	Operating temperature
CNEE01	SOP-8	Tape and Reel, 2500/Reel	40°C 40 95°C
CN5501	DFN-8	Tape and Reel, 5000/Reel	-40° C to 85° C

Pin Description

Pin No.	Name	Function Description		
		LED Current Equalizing Pin. This pin should be connected to other		
1	EQ	CN5501's EQ pin for equalizing LED current when multiple CN5501 are used		
		in parallel to drive multiple LED strings.		
2	EN	High Voltage Enable Pin. Drive EN pin to high to enable the output.		
3	GND	Ground Terminal. This pin is the negative terminal of input supply.		
		LED Current Sense Pin. The LED current is sensed and set by the resistor		
		between CS pin and GND. The equation to calculate the LED current is:		
4	4 CS	$I_{LED} = 0.153 \div (R_{CS} + 0.03)$		
		Where, I _{LED} is the LED current in ampere(A)		
		R_{CS} is the resistance from CS pin to GND in ohm(Ω)		
5	LED	Current Sink Pin. Drain of the on-chip power MOSFET, the LED string(s)		
should be con		should be connected between LED pin and VIN.		
6 VIN Positive		Positive Terminal of Input Supply. This pin is the power supply of internal		
0	VIIN	circuit.		
		+5V Regulator Output Pin. A voltage of 5V(Typical) is output out of this		
7	VCC	pin with 3mA output capability.		
		Connect a 2.2µF to 10uF compensation capacitor from VCC pin to GND.		
8	NC	No Connection.		
	EP	Exposed Pad. Connect to the GND plane for effective power dissipation. Do		
_	EP	not use as the only ground connection.		

Absolute Maximum Ratings

VIN, EN and LED Pin Voltage0.3V to 36V	Operating Temperature -40° C to 85° C
Other Pins Voltage0.3V to 6.5V	Maximum Junction Temperature150°C
Thermal Resistance(Junction to Case)65°C/W	Storage Temperature $-65^{\circ}\mathrm{C}$ to $150^{\circ}\mathrm{C}$
Lead Temperature(Soldering)260°C	

Stresses beyond those listed under 'Absolute Maximum Ratings' may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to Absolute Maximum Rating Conditions for extended periods may affect device reliability.

Electrical Characteristics

(VIN=15V, $T_A = -40^{\circ}\text{C}$ to 85°C, unless otherwise noted)

Parameters	Symbol	Test Conditions	Min	Тур	Max	Unit	
Input Supply Voltage	VIN		4		32	V	
Operating Current	I_{VIN}	V_{EN} =VIN, no LED current	220	320	420	uA	
Shutdown Supply Current	I_{SD}	$V_{EN} \leqslant 0.3V$			3	uA	
VIN Under Voltage Lockout	$V_{ m UVLO}$	V_{EN} =VIN and VIN rises from 2.5V until V_{CS} >100mV		2.85	3.35	V	
VIN Under Voltage Lockout Hysteresis	H_{UVLO}			0.22		V	
CURRENT REGULAT	ION						
The CS pin voltage	V_{CS}	$R_{CS}=3 \Omega$, normal operation	144	152	160	mV	
LED pin Leakage	I_{LKG}	$VIN=32V, V_{EN}=0V$			10	uA	
Current Limit	I_{LIMIT}		1.15	1.5	2	A	
	$ m V_{DROP}$	I _{LED} =100mA		0.18			
Day of William		I _{LED} =300mA		0.36			
Dropout Voltage		I _{LED} =500mA		0.5	0.5		
(Note 1)		I _{LED} =750mA		0.7			
		I _{LED} =1A		0.9			
Thermal Regulation							
Thermal Regulation Temperature	T_{REG}		110	125	140	°C	
EN Pin							
EN Input Voltage High	V_{IH}		3.1			V	
EN Input Voltage Low	$V_{\rm IL}$				0.6	V	
EN Bias Current	I_{EN}		-100		+100	nA	
EN Turn-on Time	t _{ON}	EN's rising edge to 90% of LED current		270		uS	
+5V Regulator(VCC Pin)							
VCC Voltage	VCC	$0 \le I_{VCC} \le 2mA, VIN \ge 5.5V$	4.7	5	5.35	V	
Short Circuit Current		VCC=0V		4.4		mA	

Note 1: Dropout voltage is measured across LED pin and CS pin when LED current is decreased by 5%.

Detailed Description

The CN5501 is a high-current regulator capable of providing up to a total of 1A of current to one or more strings of high-brightness LEDs. A wide operating input voltage range of +4V to +32V makes the CN5501 ideal for automotive applications.

A +5V regulated output provides up to 3mA of current to power external circuitry. EQ pin can equalize the LED current among multiple CN5501 used in parallel to drive multiple LED strings. In addition, the CN5501 features thermal regulation instead of thermal shutdown. If the voltage drop across LED pin and CS pin is high, or the LED current is large, or both the voltage drop and LED current are large, CN5501 will become heater, when the silicon temperature reaches 125°C, the on-chip thermal regulation circuit begins to function, the LED current will be decreased to keep CN5501's silicon temperature at 125°C (typical).

The wide operating voltage range helps protect the CN5501 against large transients such as those found in load-dump situations up to 32V.

The CN5501 uses a feedback loop to control the LED current. The voltage across the sense resistor R_{CS} is compared to a fixed reference voltage, and the error is amplified to serve as the drive to the internal power MOSFET. The regulated LED current is user defined by the value of R_{CS} between CS pin and GND.

Application Information

Input Voltage Considerations

The operating voltage range of the CN5501 is $\pm 4V$ to $\pm 32V$. The device may operate below $\pm 4V$, however, LED current may not meet the full regulation specification. For proper operation, the minimum input voltage must always be higher than the worst-case sum of the forward drops of all series-connected LEDs at the output of the CN5501.

+5V Regulator

The CN5501 includes a fixed +5V output regulator that delivers up to 3mA of load current for low-power applications throughout the +5.5V to +32V input voltage range. Connect a $2.2\mu F$ to $10\mu F$ compensation capacitor from VCC pin to GND.

The +5V output can be used to power the external circuitry.

Thermal Regulation

The CN5501 features thermal regulation instead of thermal shutdown. If the voltage drop across LED pin and CS pin is high, or the LED current is large, or both the voltage drop and LED current are large, CN5501 will become heater, when the silicon temperature reaches 125°C, the on-chip thermal regulation circuit begins to function, the LED current will be decreased to keep the silicon temperature at 125°C (typical). This typically occurs in overload or LED short-circuit conditions.

Setting the LED Current

The CN5501 uses a current sense resistor between CS pin and GND to set the LED current. The LED current is given by the equation below:

$$I_{LED} = 0.153 \div (R_{CS} + 0.03)$$

Where, I_{LED} is the LED current in ampere(A)

 R_{CS} is the resistance from CS pin to GND in ohm(Ω)

PWM Dimming

The CN5501 provides pulsed or chopped current dimming. Generally, high-brightness LEDs are binned to match at their full-rated current. However, LEDs from the same bin exhibit poor matching at currents other than full-rated current. To achieve uniformity, high brightness LED manufacturers recommend PWM pulsing of the LED current at their full-rated value. This can be achieved by pulsing the enable input (EN) while having a constant voltage at VIN, as shown in Figure 2. The PWM signal frequency should be less than 300Hz.

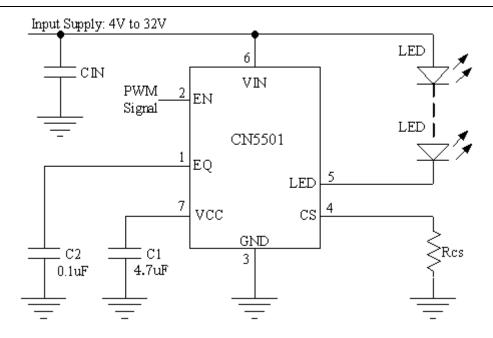


Figure 2 PWM Dimming

Driving Multiple LED Strings

When multiple LED strings need to be driven, multiple CN5501 can be used in parallel, each CN5501 drives one LED string. In this case, the current flowing through each LED string can be equalized by connecting every CN5501's EQ pin together, as shown in Figure 3.

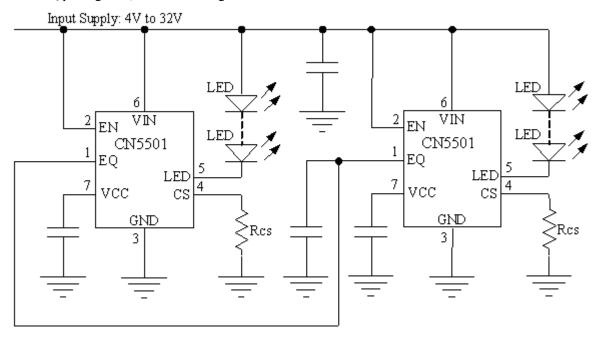


Figure 3 Multiple CN5501 Used In Parallel

VIN Bypass Capacitor CIN

In most applications, a high-frequency bypass capacitor at the input is needed. Generally A 1uF ceramic capacitor, placed in close proximity to VIN and GND pins, works well. In some applications depending on the power supply characteristics and cable length, it may be necessary to increase the capacitor's value. For the

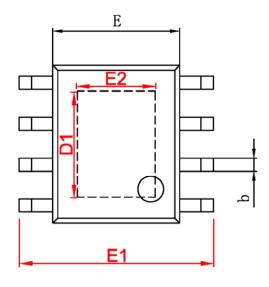
consideration of the bypass capacitor, please refer to the Application Note AN102 from our website.

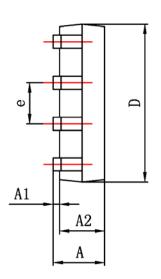
PCB Layout Considerations

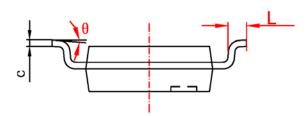
- 1. R_{CS} at CS pin should be as close to CN5501 as possible.
- 2. The capacitor at VCC pin should be as close to CN5501 as possible.
- 3. It is very important to use a good thermal PC board layout to maximize LED current and minimize the drop out voltage. The thermal path for the heat generated by the IC is from the die to the copper lead frame, through the package lead(especially the ground lead) to the PC board copper, the PC board copper is the heat sink. The footprint copper pads should be as wide as possible and expand out to larger copper areas to spread and dissipate the heat to the surrounding ambient. Feedthrough vias to inner or backside copper layers are also useful in improving the overall thermal performance of the LED driver. Other heat sources on the board, not related to the LED driver, must also be considered when designing a PC board layout because they will affect overall temperature rise and the maximum LED current.

The ability to deliver maximum LED current under all conditions require that the exposed metal pad on the back side of the CN5501 package be soldered to the PC board ground. Failure to make the thermal contact between the exposed pad on the backside of the package and the copper board will result in larger thermal resistance.

Package Information (SOP8)

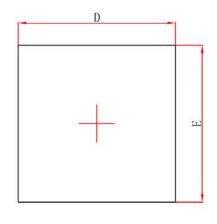


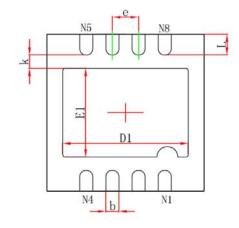




Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
Α	1. 350	1. 750	0. 053	0.069	
A1	0. 050	0. 150	0. 004	0. 010	
A2	1. 350	1. 550	0. 053	0. 061	
b	0. 330	0. 510	0. 013	0. 020	
С	0. 170	0. 250	0. 006	0. 010	
D	4. 700	5. 100	0. 185	0. 200	
D1	3. 202	3. 402	0. 126	0. 134	
E	3. 800	4. 000	0. 150	0. 157	
E1	5. 800	6. 200	0. 228	0. 244	
E2	2. 313	2. 513	0. 091	0. 099	
е	1. 270 (BSC)		0. 050 (BSC)		
L	0. 400	1. 270	0. 016	0. 050	
θ	0°	8°	0°	8°	

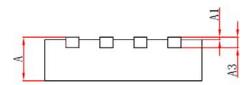
Package Information (DFN-8)





Top View

Bottom View



Side View

Symbol	Dimensions I	n Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
Α	0.700/0.800	0.800/0.900	0.028/0.031	0.031/0.035	
A1	0.000	0.050	0.000	0.002	
A3	0.203REF.		0.008REF.		
D	2.900	3.100	0.114	0.122	
E	2.900	3.100	0.114	0.122	
D1	2.300	2.500	0.091	0.098	
E1	1.600	1.800	0.063	0.071	
k	0.200MIN.		0.008MIN.		
b	0.180	0.300	0.007	0.012	
е	0.500TYP.		0.020TYP.		
L	0.300	0.500	0.012	0.020	

Consonance does not assume any responsibility for use of any circuitry described. Consonance reserves the right to change the circuitry and specifications without notice at any time.